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<th>Item</th>
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<th>Manufacturer</th>
<th>PartNumber</th>
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<td>C1</td>
<td>CAP, CERM, 4.7uF, 100V, +20%, X7R, 2220</td>
<td>TDK</td>
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<td>TRANSISTOR NPN, 80V, SOT23-3</td>
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<td>R5, R8, R9</td>
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<td>R6</td>
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<td>U1</td>
<td>TPS92690 NFET Controller, 16 Lead eTSSOP</td>
<td>Texas Instruments</td>
<td>TPS92690</td>
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</tbody>
</table>
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